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**** CONTINUING DATA *******

This application is a DIV of 10/009,168 12/07/2001 PAT 6,702,175 *AM*

**** FOREIGN APPLICATIONS *******

JAPAN 11-165165 06/11/1999

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 04/21/2004

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY JAPAN	SHEETS DRAWING 5	TOTAL CLAIMS 19	INDEPENDENT CLAIMS 1
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged Examiner's Signature <i>[Signature]</i> Initials <i>AM</i>				

ADDRESS

000513

TITLE

Method of soldering lead-free solder, and joined object soldered by the soldering method

FILING FEE RECEIVED 770	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
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